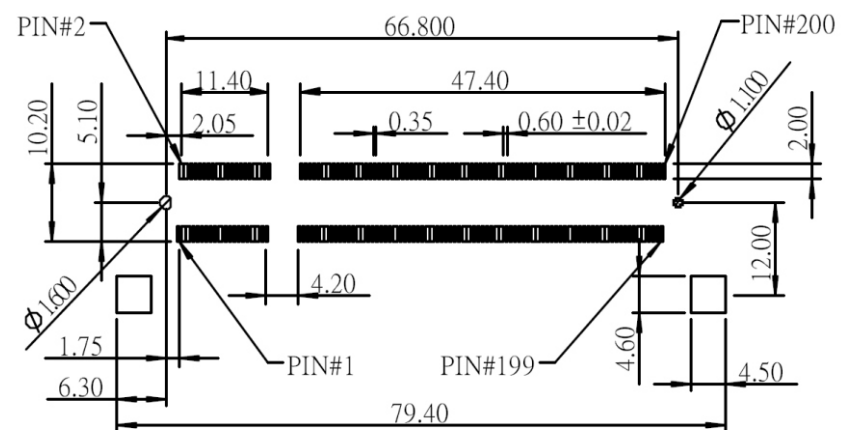


NOTE:

- SOLDERTAIL TO BE WITHIN 0.05 UPWARD AND 0.2 DOWNWARD FROM Z-DATUM PLACE, AND COPLANALITY OF SOLDERTAILS TO BE WITHIN 0.10. MEASUREMENT POINT IS SOLDERTAILS TIP.
- CONTACT PLATING: UNDERPLATE 50 μ "NICKEL. CONTACT AREA: GOLD 3 μ ". SELECTIVE SOLDERTAILS AREA
- INSPECTION SYMBOL:
 ● : MANUFACTURER INSPECTION
 ◆ : Q.C INSPECTION

SDM6-W80V25-A640-LF
LEADFREE

RoHS Compliant



PART NO. SDM6-W80V25-A640

DWG NO. SDM6-W80V25-A640

CHECKED BY CY

TOLERANCES ARE

FILE NO.

DRAWING BY

.X ± 0.2
.XX ± 0.1

DESCRIP TION:

DDR S.O DIMM 200P ASSEMBLY

煜倫股份有限公司

UNIT / mm

SCALE 1:1

PROJECTION

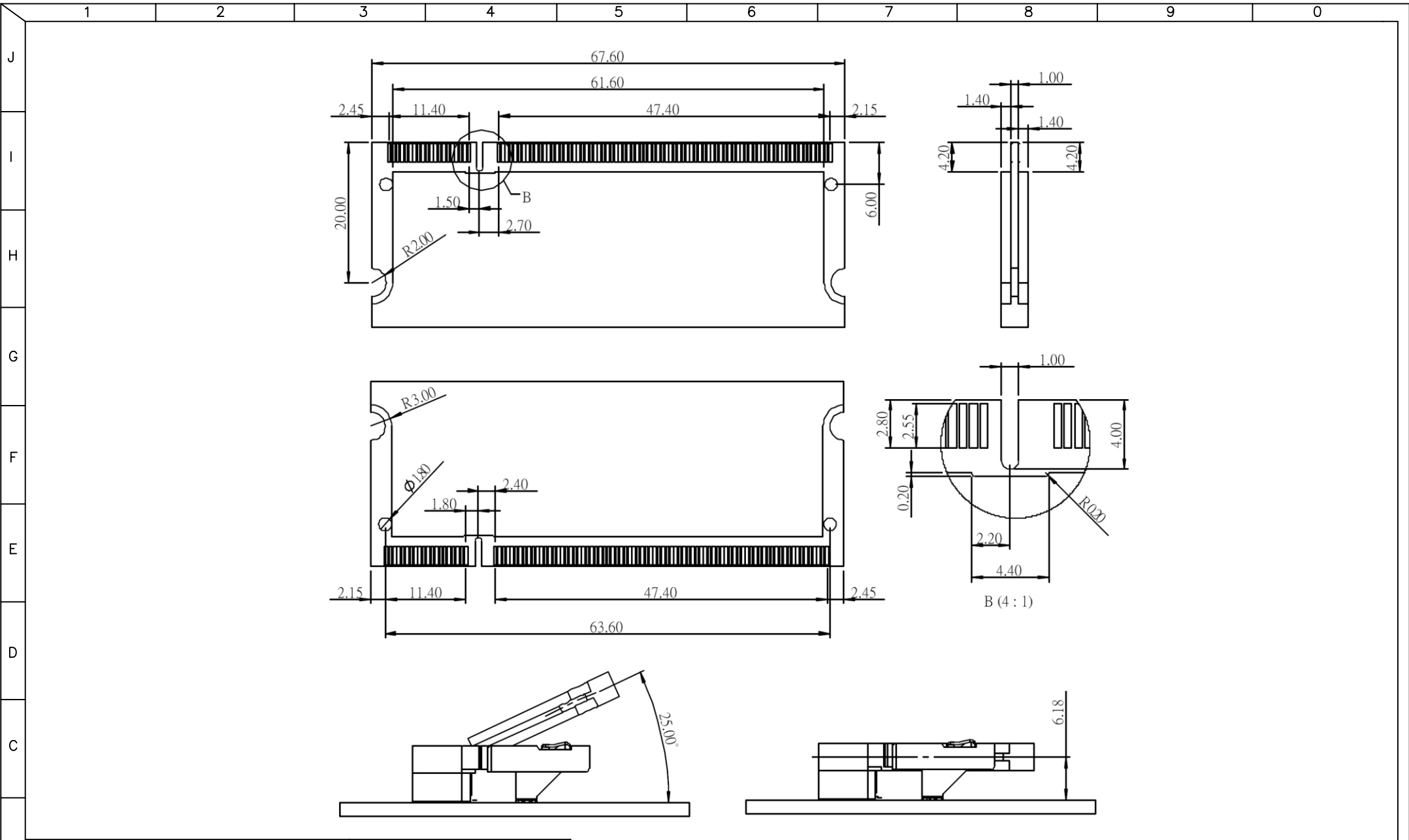
.XXX ± AWG

AREA

REVISIONS

HK

DATE



MORETHANALL
CONNECTORS
ASSEMBLIES

PART NO. SDM6-W80V25-A640

DWG NO. SDM6-W80V25-A640

CHECKED BY CY

TOLERANCES ARE

DESCRIPTION:

煜倫股份有限公司

FILE NO.

DRAWING BY

.X ± 0.2
.XX ± 0.1
.XXX ±
AWG

UNIT / mm

SCALE 1:1

PROJECTION

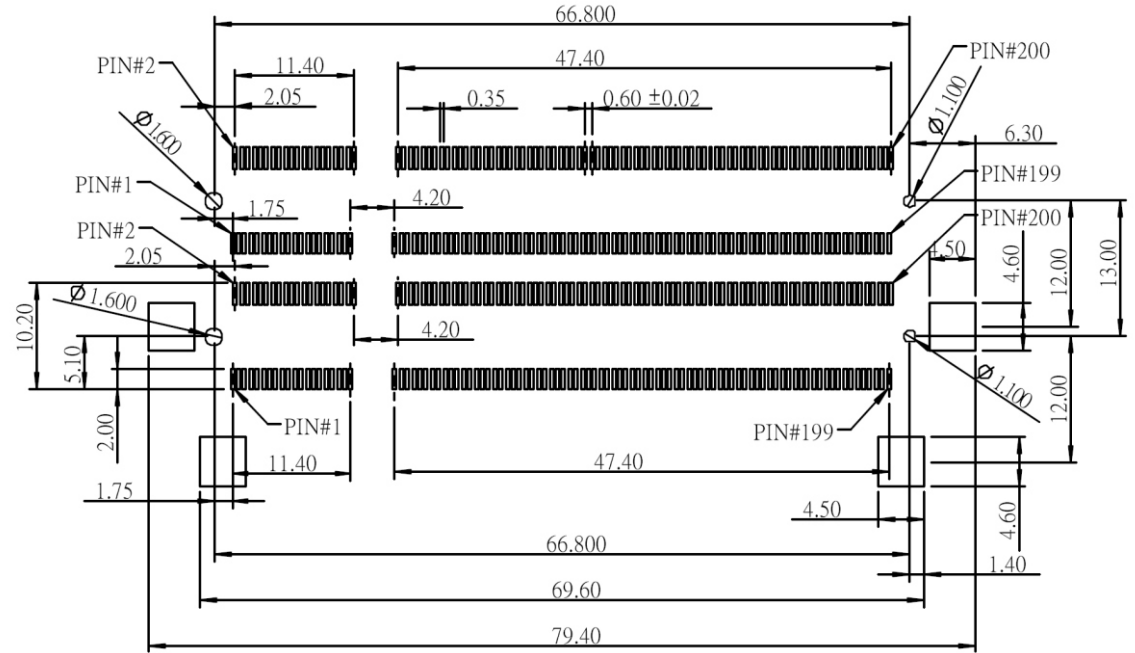
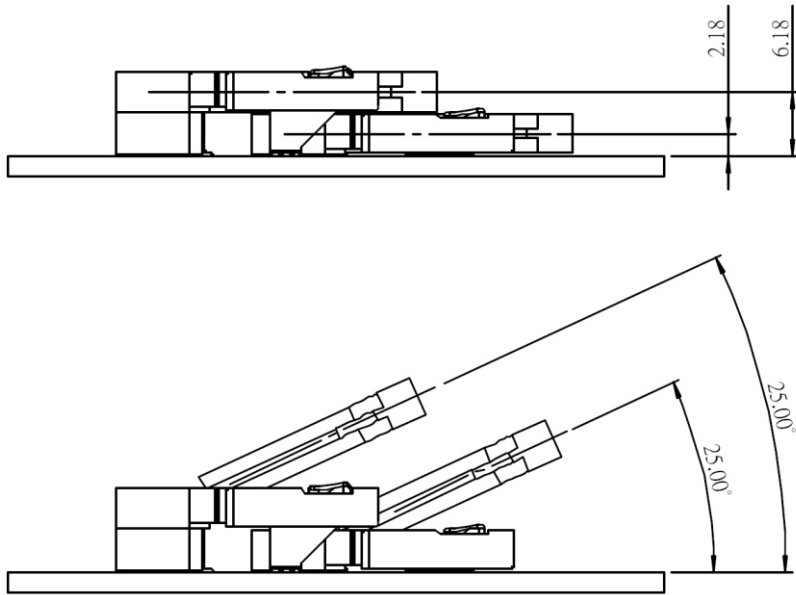
AREA

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DDR S.O. DIMM 200P 4.0&8.0 OVERLAY FIGURE



PCB LAYOUT : COMPONENT SIDE(4.0&8.0 TYPE)



PART NO. SDM6-W80V25-A640

DWG NO. SDM6-W80V25-A640

CHECKED BY CY

TOLERANCES ARE

DESCRIP TION:

煜倫股份有限公司

FILE NO.

DRAWING BY

.X ± 0.2

.XX ± 0.1

.XXX ±

AWG

AREA

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UNIT / mm

SCALE 1:1

PROJECTION

